



Product Termination Notification



Product Group: Vishay Siliconix/May 10, 2018/PCN- SIL-0082018 Rev0

End of Life Notification – SQ7414AEN

DESCRIPTION OF CHANGE: This document is being issued to you to announce that Vishay part number SQ7414AEN-T1_GE3 is being discontinued and replaced by SQ7414CENW-T1_GE3. This replacement represents a migration to more advanced Silicon technologies and material sets that are currently supported in Vishay's high-volume production.

CLASSIFICATION OF CHANGE: Material Set Conversion

REASON FOR CHANGE: Migration to advanced technologies

EXPECTED INFLUENCE ON QUALITY/RELIABILITY/PERFORMANCE: None

PRODUCT CATEGORY: Automotive MOSFETs

VISHAY PART NUMBERS AFFECTED:

Affected Part	Replacement Part
SQ7414AEN-T1_GE3	SQ7414CENW-T1_GE3

VISHAY BRAND(s): Vishay-Siliconix

TIME SCHEDULE: Last time buy orders for SQ7414AEN-T1_GE3 are required before November 10, 2018 with last shipment scheduled before May 10, 2019.

QUALIFICATION DATA: AEC Q101 qualification data of the replacement product is available now. A generic PPAP is available upon request.

SAMPLE AVAILABILITY: Qualified samples of replacement product are available immediately. For samples, please email automos.pcn@vishay.com with subject PCN SIL-0082018 in the subject line and include required quantity and ship-to address.

ISSUED BY: Dave MacDonald, Sr. Manager Technical Marketing (E-mail: Dave.macdonald@Vishay.com)

For further information, please contact your regional Vishay office.

The Americas

Vishay Americas
2201 Laurelwood Road
Santa Clara, Ca 95054
T: 408-988-8000
F: 408-567-8500

Europe

Vishay Electronic GmbH
Geheimrat-Rosenthal-Strasse 100
D-95100
Selb, Germany
T: 49-9287-71 0
F: 49-9287-70435

Asia

Vishay Intertechnology Asia Pte. Ltd
37A Tampines Street 92
#07-00 Keppel Building
Singapore 528886
T: 65-6788-6668
F: 65-6788-0988

Vishay Intertechnology, Inc.

Corporate Headquarters 63 Lincoln Highway, Malvern, PA 19355-2143 U.S.A. Phone (610) 644-1300 Fax (610) 296-0657 www.vishay.com

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